

1. Record Nr.	UNISA996384475003316
Autore	Erasmus Desiderius <d. 1536.>
Titolo	Jvlivs secundus [[electronic resource]] : dialogvs anonymi cujusdam authoris festiuis sane ac elegans : interlocutores Julius, Genius, S. Petrus : lector risum cohibe : dialogo præfixum est ab editore Colliquim, dialogistæ quæ fieri potuit, exquirendo destinatum, quem magnum illum fuisse Erasmum, tam rationibus, quam testimoniis efficitur : Julio Secundo accessit Euclides catholicus, Rom. ecclesiæ fidem non minus lepide demonstrans, quam mores artesque Rom. pontificum graphice depinxit Erasmus
Pubbl/distr/stampa	Oxonii, : [s.n.], MDCLXXX [1680]
Descrizione fisica	[16], 40, [12], 76 p
Lingua di pubblicazione	Latino
Formato	Materiale a stampa
Livello bibliografico	Monografia
Note generali	"Though Erasmus repeatedly denied the authorship of this work, modern scholars are agreed that he wrote it. CF. P.S. Allen Opus epistolarum Des. Erasmi, II, p. 418-20, & The age of Erasmus, p. 184-89; Erasmi opuscula, ed. by W.K. Ferguson, p. 38-54; & J.B. Pineau in Revue de litterature comparee, V (1925) p. 385-415."--NUC pre-1956 imprints. Item at reel 1637:2 is a replacement copy for the incomplete Union Theological Seminary Library copy at reel 1405:29. Reproduction of originals in the Union Theological Seminary Library, New York, and the Huntington Library.
Sommario/riassunto	eebo-0160

2. Record Nr.	UNINA9910791834003321
Titolo	Integrated circuits, photodiodes and organic field effect transistors [[electronic resource] /] / Robert McIntire and Pierre Donnell, editors
Pubbl/distr/stampa	New York, : Nova Science Publishers, c2009
ISBN	1-61761-868-3
Descrizione fisica	1 online resource (458 p.)
Collana	Environmental Research Advances
Altri autori (Persone)	McIntireRobert DonnellPierre
Disciplina	621.3815
Soggetti	Diodes Organic field-effect transistors
Lingua di pubblicazione	Inglese
Formato	Materiale a stampa
Livello bibliografico	Monografia
Note generali	Description based upon print version of record.
Nota di bibliografia	Includes bibliographical references and index.
Nota di contenuto	""INTEGRATED CIRCUITS,PHOTODIODES AND ORGANIC FIELDEFFECT TRANSISTORS""; ""CONTENTS""; ""PREFACE""; ""RESEARCH AND REVIEW STUDIES""; ""METAMATERIALS TECHNOLOGY: APPLICATIONTO RADIOFREQUENCY AND MICROWAVE CIRCUITS""; ""ABSTRACT""; ""1. INTRODUCTION TO METAMATERIALS""; ""2. METAMATERIALS IN PLANAR TECHNOLOGY:METAMATERIAL TRANSMISSION LINES""; ""2.1. The Dual Transmission Line Concept""; ""2.2. CL-Loaded Lines: The Composite Right/Left Handed TransmissionLine Concept""; ""2.3. Resonant Type Metamaterial Transmission Lines""; ""3. APPLICATIONS OF METAMATERIAL TRANSMISSION LINES"" ""3.1. Metamaterial Filters""""3.1.1. Stop Band Filters: Application to Spurious Suppression in ConventionalFilters""; ""3.1.2. Narrow Band Pass Filters and Dplexers""; ""3.1.3. Wide and Ultra Wide Band (UWB) Pass Filters""; ""3.1.4. Metamaterial Based Filters Subjected to Standard Responses:A Design Methodology""; ""3.2. Enhanced Bandwidth Components""; ""3.3. Multiband Components""; ""4. CONCLUSION""; ""REFERENCES""; ""RELIABILITY ASSESSMENT OF INTEGRATEDCIRCUITS AND ITS MISCONCEPTION""; ""ABSTRACT""; ""I. THE IMPORTANCE OF INTEGRATED CIRCUIT RELIABILITY"" ""II. COMMON RELIABILITY PRACTICES IN INTEGRATEDCIRCUIT INDUSTRY""""1. Process Reliability Test in Wafer Fabrication Manufacturers""; ""2. Product Reliability Tests in IC Assembly and

Packaging Manufacturers"; "3. Highly Accelerated Stress Test (HAST)";
"III. MISCONCEPTIONS IN COMMON RELIABILITY ASSESSMENT OF
INTEGRATED CIRCUITS"; "1. Zero Failure Represents Good Reliability";
"2. Higher MTTF Represents Better Reliability"; "3. MTTF Is the Mean
Failure Time"; "4. Exponential Distribution Is Sufficient to Analyze the
Test Data"
"5. The Higher the Stress, the More Effective Is the Reliability Test"
"A. Masked Failure Mechanism"; "B. Variation of Failure Mechanism"; "6.
All Test Data Are Valid"; "7. Only One Failure Mechanism Exist in the
Failed Units"; "8. Probability Plot Is Sufficient for Test Data Analysis";
"9. Small Sample Size Is Sufficient"; "10. The Important of Confidence
Interval"; "IV. CONCLUSION"; "REFERENCES"; "DESIGN OF A
MULTICHANNEL INTEGRATED BIOSENSOR CHIP AND MICROELECTRONIC
SYSTEM FOR EXTRACELLULAR NEURAL RECORDING"; "ABSTRACT"; "1.
INTRODUCTION"; "2. SYSTEM OVERVIEW"
"3. SYSTEM ARCHITECTURE AND DESIGN"
"3.1. Neural Signal Input";
"3.2. Preamplifier Buffers"; "3.3. Analysis and Design of the Two-
Stage Amplifier Based Preamplifier Buffer"; "3.3.1. Device Model";
"3.3.2. Frequency Response and Pole/Zero Locations"; "3.3.3. Output
Swing"; "3.3.4. Common-Mode Input Range"; "3.3.5. Internal Slew
Rate"; "3.3.6. External Slew Rate"; "3.3.7. Systematic Input-Referred
Offset Voltage Minimization"; "3.3.8. Input-Referred Thermal Noise";
"3.3.9. Preamplifier Buffer Design"; "3.4. Channels Addressing and
Sequencing"
"3.5. Biasing Circuitry"
